**CURRICULUM VITAE**
**(Maximum Four Pages)**

All information provided in this form will be used for processing the application and related purposes by Innovation and Technology Commission (ITC) and the associated university. It may be disclosed to other Government bureaux/departments, statutory bodies or third parties for the above said purposes or required by law. This submission denotes that the start-up and its team members concerned as well as the university unit responsible for TSSSU have given explicit consent to such disclosure.

**Personal Particulars**

|  |  |  |
| --- | --- | --- |
| Name in English | : | [Title] [First name here] [Last name here] |
| Name in Chinese | : |  |
| Position held in Applicant Company | : |  |
|  |  |  |
| Affiliation with Recommending University (if applicable, e.g. undergraduate/‌postgraduate, alumnus, professor/faculty member – please specify the post title) | : |  |
| Faculty/Department inRecommending University (if applicable) | : |  |
|  |  |  |
| Tel No | : |  |
| E-mail Address | : |  |

**Academic/Professional Qualifications** (in chronological order. i.e. order of time from the earliest to the latest)**:**

|  |  |  |
| --- | --- | --- |
| **Year of Award** | **Institution of Learning /****College / University Attended (Please specify country)** | **Qualifications / Awards / Distinctions****Obtained** |
|  |  |  |
|  |  |  |
|  |  |  |
|  |  |  |

|  |  |  |
| --- | --- | --- |
| **Year of Award** | **Professional Body** | **Qualification / Membership Obtained** |
|  |  |  |
|  |  |  |

**Working Experience** (in chronological order. i.e. order of time from the earliest to the latest)**:**(Project management experience, if any, should be included)

|  |  |  |  |  |
| --- | --- | --- | --- | --- |
| **From****(MM/YYYY)** | **To****(MM/YYYY)** | **Name of Employer** | **Appointment Held** | **Nature of Work** |
|  |  |  |  |  |
|  |  |  |  |  |
|  |  |  |  |  |
|  |  |  |  |  |

**Publications** (maximum five publications related to the application)**:**

|  |  |  |
| --- | --- | --- |
|  | **Year** | **Title of Published Work** |
| **1.** |  |  |
| **2.** |  |  |
| **3.** |  |  |
| **4.** |  |  |
| **5.** |  |  |

**Intellectual Property Rights (e.g. patents, copyrights, etc) Owned:**

|  |  |  |  |  |
| --- | --- | --- | --- | --- |
| **IP Type****(e.g. patents, copyrights, etc)** | **IP Status – Patent only (Please indicate: Filed, Granted)** | **Date****(DD/MM/YYYY)** | **Patent or Publication number (if applicable)** | **Title** |
|  |  |  |  |  |
|  |  |  |  |  |
|  |  |  |  |  |
|  |  |  |  |  |